

EMIF10-LCD02F3

10-line IPAD[™], EMI filter and ESD protection for LCD and cameras

Features

- Lead-free package
- EMI symmetrical (I/O) low-pass filter
- High efficiency in EMI filtering
- 400 µm pitch
- Compatible with high speed data rate
- Very low PCB space occupation: < 4mm²
- Very thin package: 0.60 mm
- High efficiency in ESD suppression
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging

Complies with the following standards

- IEC61000-4-2 level 4 on inputs and outputs
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- MIL STD 883E Method 3015-6 Class 3

Applications

Where EMI filtering in ESD sensitive equipment is required :

- LCD for mobile phones
- Computers and printers
- Communication systems
- MCU boards

Description

April 2008

The EMIF10-LCD02F3 is a 10-line highly integrated device designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interference. The EMIF10 Flip Chip packaging means the package size is equal to the die size.

This filter includes ESD protection circuitry, which prevents damage to the protected device when subjected to ESD surges up 15kV.

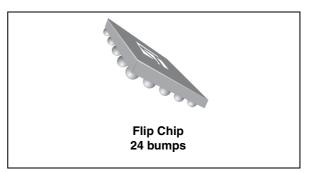


Figure 1. Pin layout (bump side)

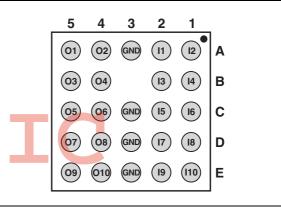
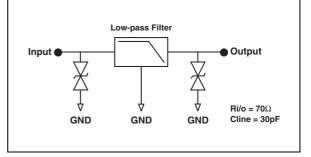


Figure 2. Device configuration



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Characteristics

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Characteristics

Table 1.Absolute maximum ratings ($T_{amb} = 25 \ ^{\circ}C$)

Symbol	Parameter and test conditions	Value	Unit
Тj	Maximum junction temperature	125	°C
T _{op}	Operating temperature range	-40 to +85	°C
T _{stg}	Storage temperature range	-55 to 150	°C

Table 2.

2. Electrical characteristics (T_{amb} = 25 °C)

Symbol	Parameters					
V _{BR}	Breakdown voltage	` ↑ /				
I _{RM}	Leakage current @ V _{RM}	le				
V _{RM}	Stand-off voltage] /.				
V _{CL}	Clamping voltage					
I _{PP}	Peak pulse current					
R _{I/O}	Series resistance between Input & Output					
C _{line}	Input capacitance per line		I			
Symbol	Test conditions		Min	Тур	Max	Unit
V _{BR}	I _R = 1 mA		6	8	10	V
I _{RM}	V _{RM} = 3 V			50	200	nA
R ₂	Tolerance ± 20%			70		Ω
C _{line}	Vline = 0 V, V_{OSC} = 30 mV, F =1 MHz				30	pF

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Figure 3. S21(dB) all lines attenuation F measurement and Aplac simulation



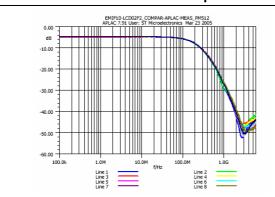
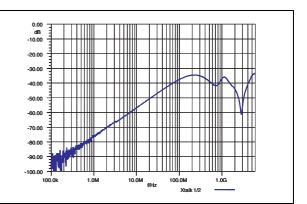


Figure 5. ESD response to IEC 61000-4-2 Figure 6. (+15 kV air discharge) on one input and on one output



ESD response to IEC 61000-4-2 (-15 kV air discharge) on one input and on one output

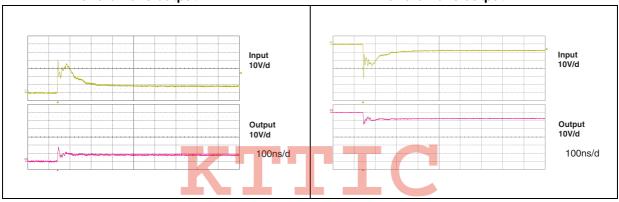
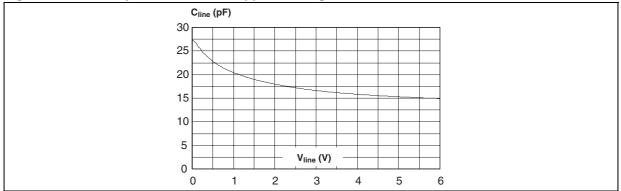


Figure 7. Line capacitance versus applied voltage



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Application information

2 Application information

Figure 8. Device structure (one cell)

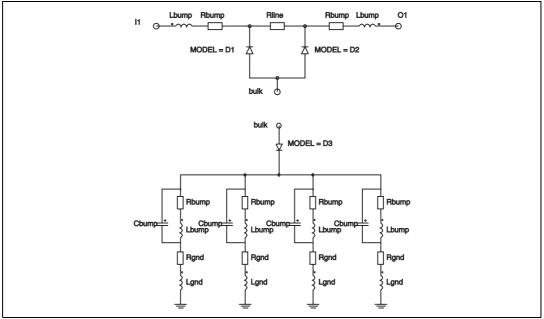


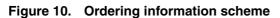
Figure 9. Aplac model variables

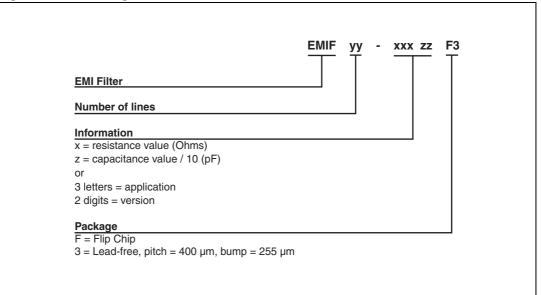
Diode D1		
Diode D1		
	Diode D2	Diode D3
	21000 22	21040 20
BV=7	BV=7	BV=7
IBV=1m	IBV=1m	IBV=1m
CJO=C_d1	CJO=C_d2	CJO=C_d3
M=0.28	M=0.28	M=0.28
RS=0.1	RS=0.1	RS=0.01
VJ=0.6	VJ=0.6	VJ=0.6
TT=100n	TT=100n	TT=100n
	CJO=C_d1 M=0.28 RS=0.1 VJ=0.6	IBV=1m IBV=1m CJO=C_d1 CJO=C_d2 M=0.28 M=0.28 RS=0.1 RS=0.1 VJ=0.6 VJ=0.6



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3 Ordering information scheme

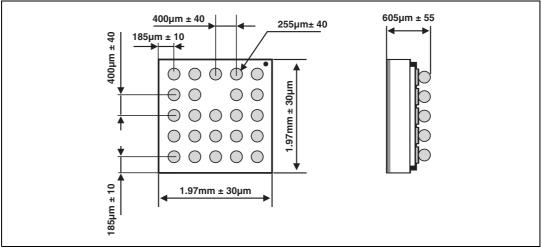




4 Package information

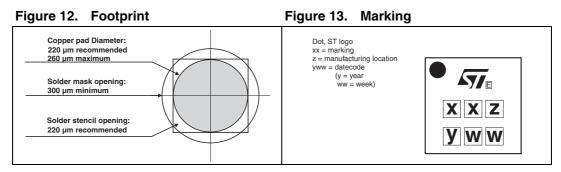
In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at *www.st.com*.



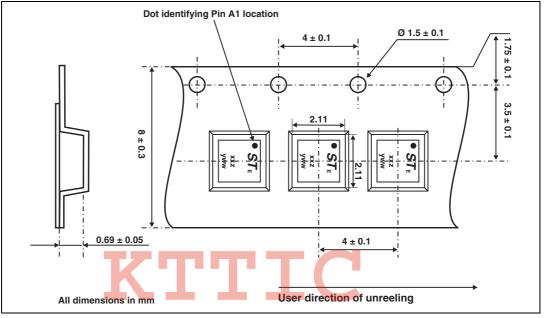


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Ordering information







Note: More information is available in the application notes: N2348: "STMicroelectronics 400 micro-metre Flip Chip: Package description and recommendation for use"

AN1751: "EMI Filters: Recommendations and measurements"

5 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF10-LCD02F3	GY	Flip Chip	5.0 mg	5000	Tape and reel 7"

Table 3. Ordering information

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6 Revision history

Table 4.Document revision history

Date	Revision	Changes
11-Jul-2005	1	First issue.
28-Apr-2008	2	Updated ECOPACK statement. Updated <i>Figure 10, Figure 11, Figure 12</i> and <i>Figure 14</i> . Reformatted to current standards.





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